

EMC challenges for electromobility

IEEE meeting 2019-11-12

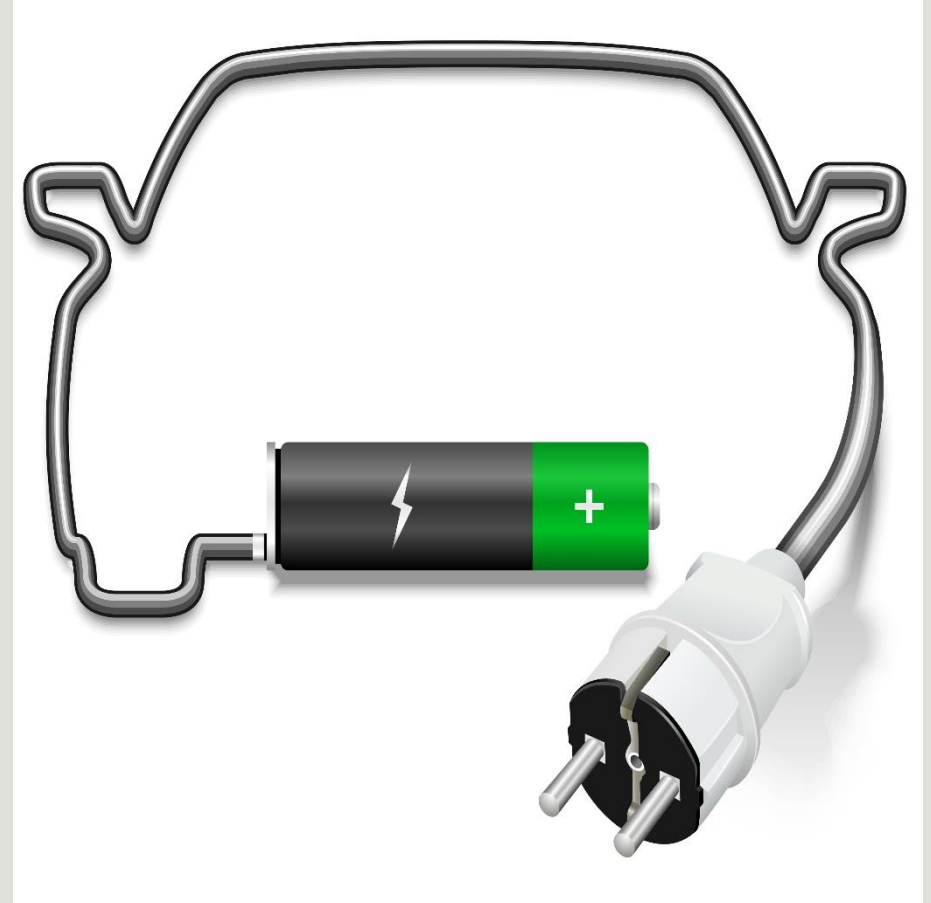
Lennart Hasselgren
Education and Consultancy Manager



Content

- What's different with E-mobility?
- What are the challenges?
 - System level
 - Shielding
 - System internal
- Summary

What's different with E-mobility?



EMC Requirements due to E-mobility

- Vehicle on road
 - UN ECE R10
- US: connected to power mains
 - FCC CFR 47 part 15B
- Marine
 - IEC 60533
 - IACS (ships classification)
- Vehicle off road
 - EN standards for machines
- Charging port has same requirement as every other domestic appliance
- To date, only China has unique EMC requirements for electric vehicles (GB/T-x).

What is the challenge?



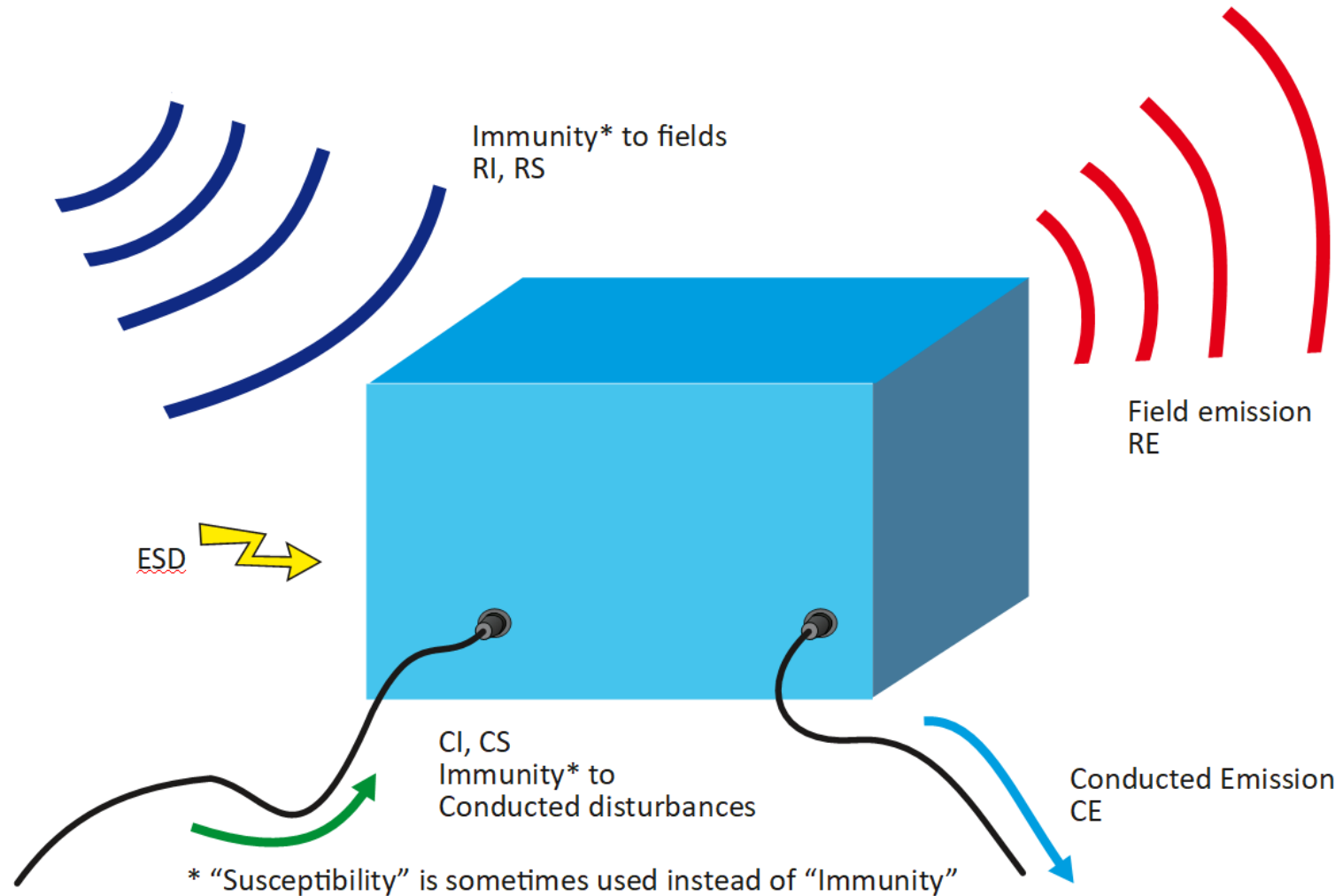
Electric vehicles and EMC



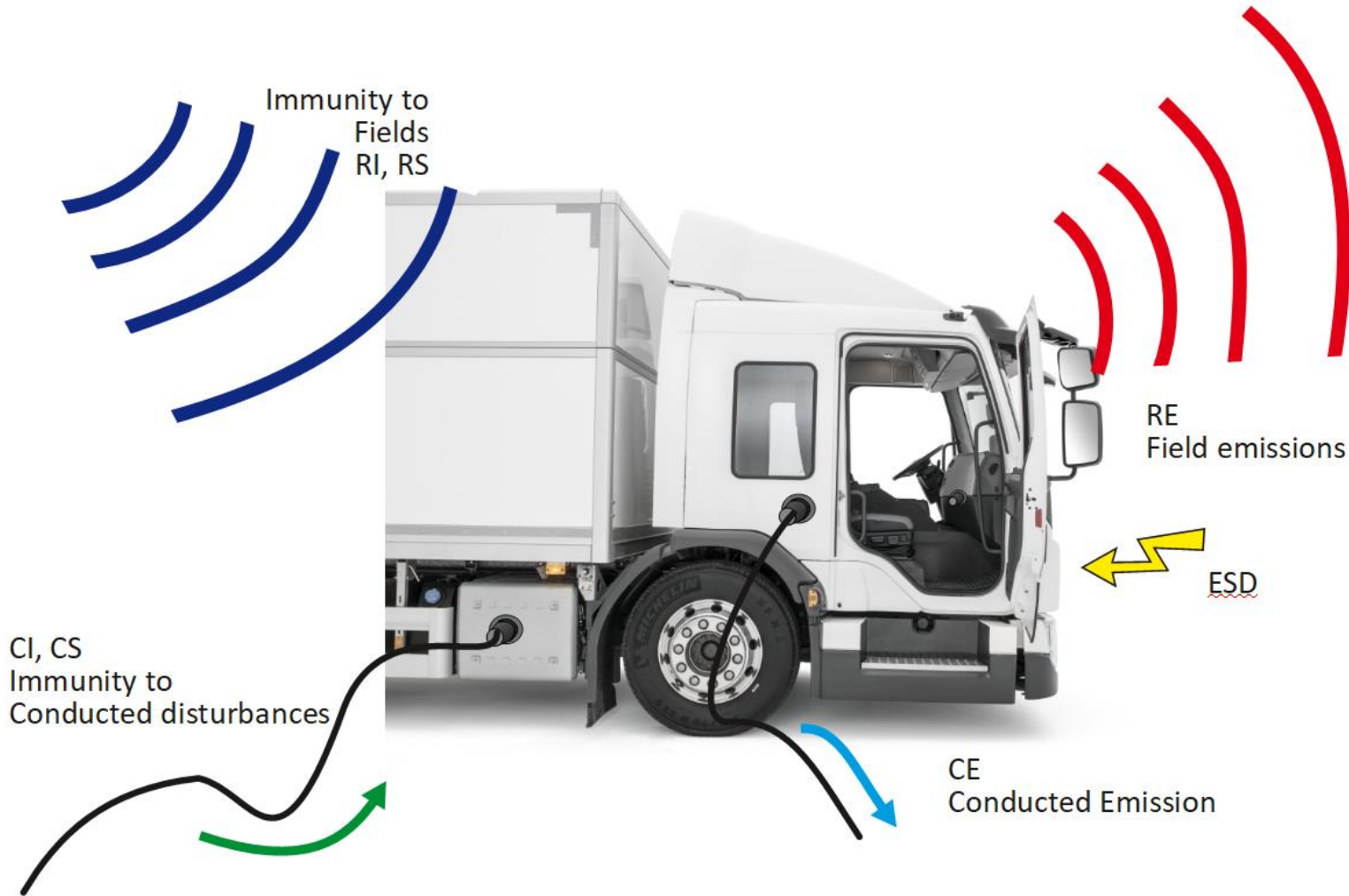
Challenge: to create a hybrid vehicle with high quality

- The car can not have lower EMC performance just because it is electric
- The environment and use is the same

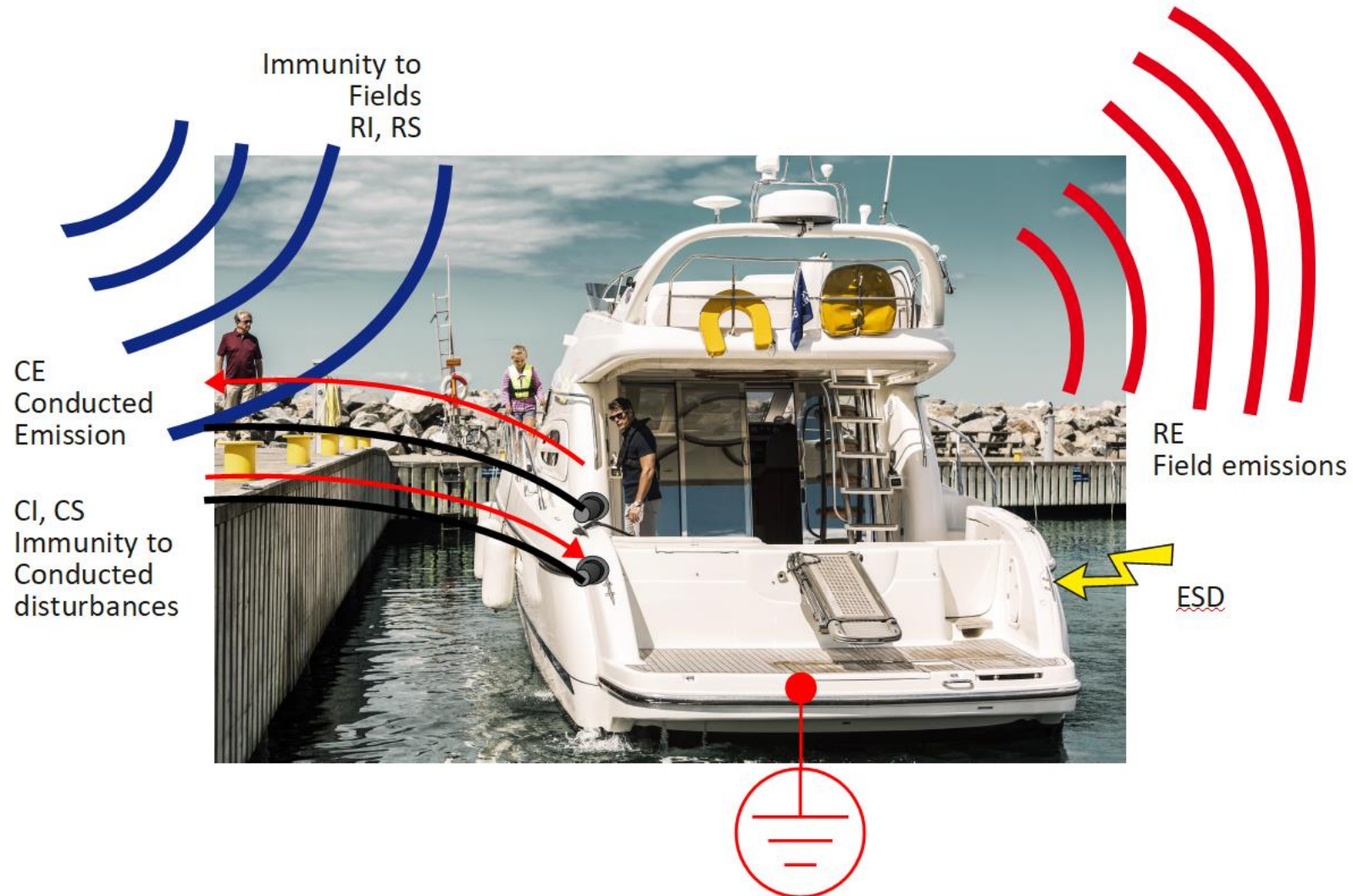
EMI risks in reality



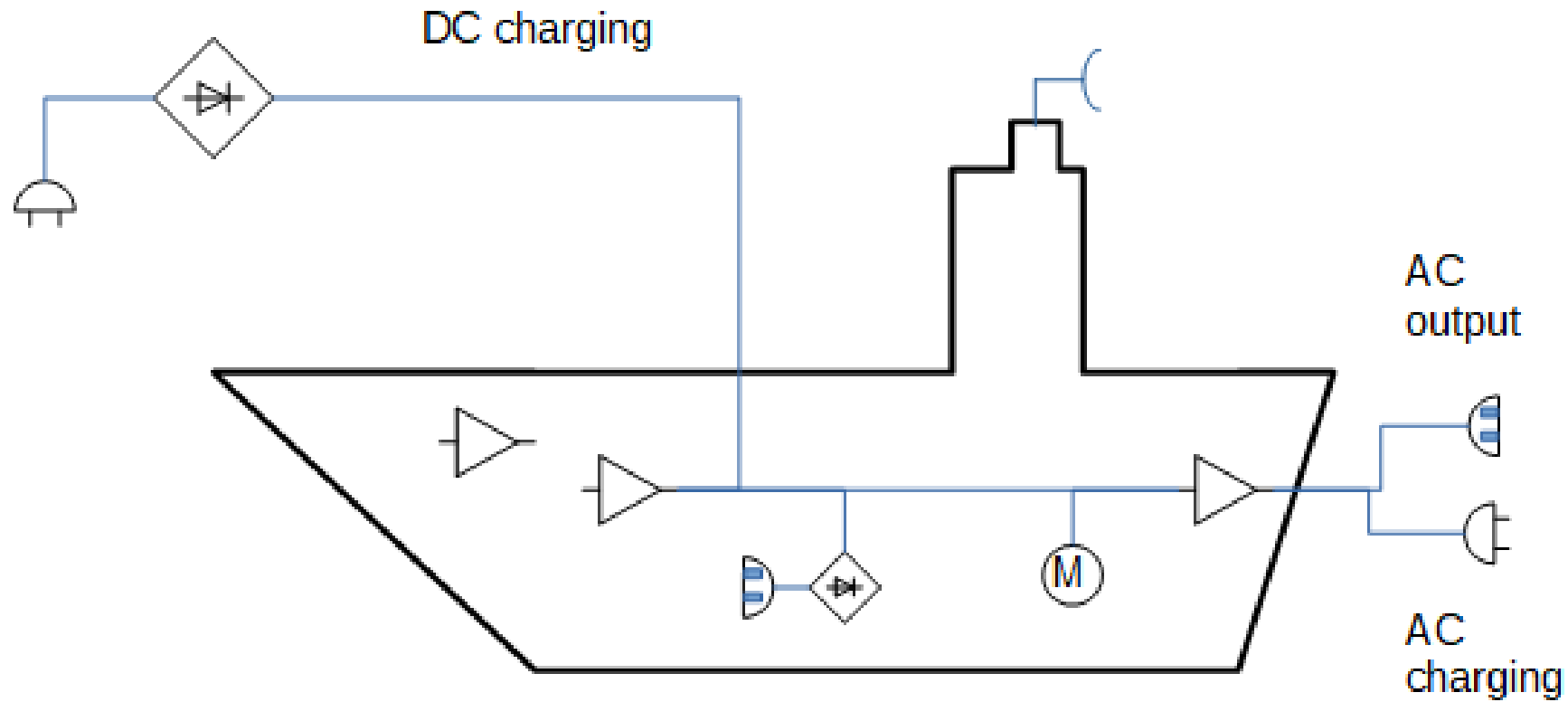
EMI risks in reality – land mobile



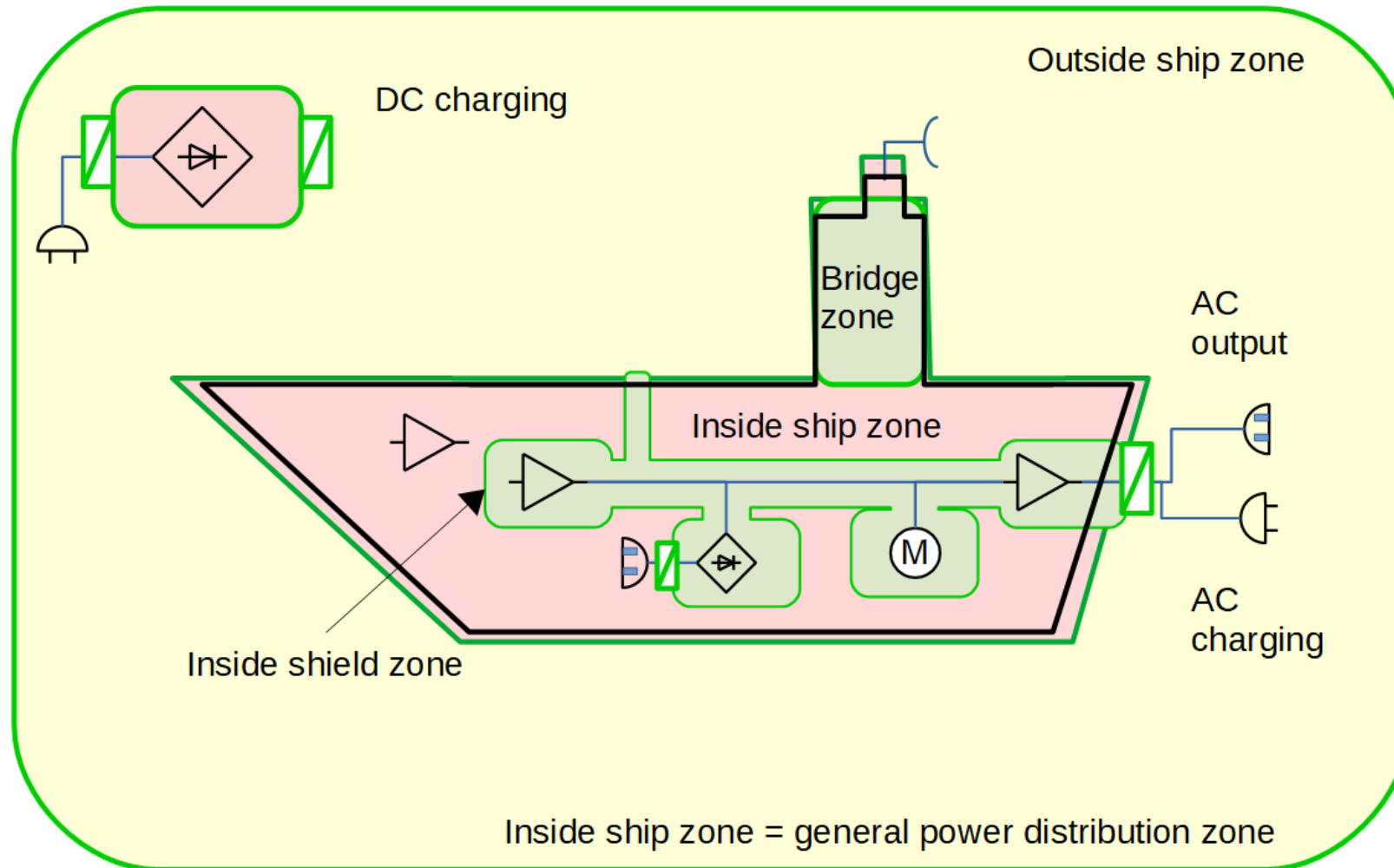
EMI risks in reality – marine



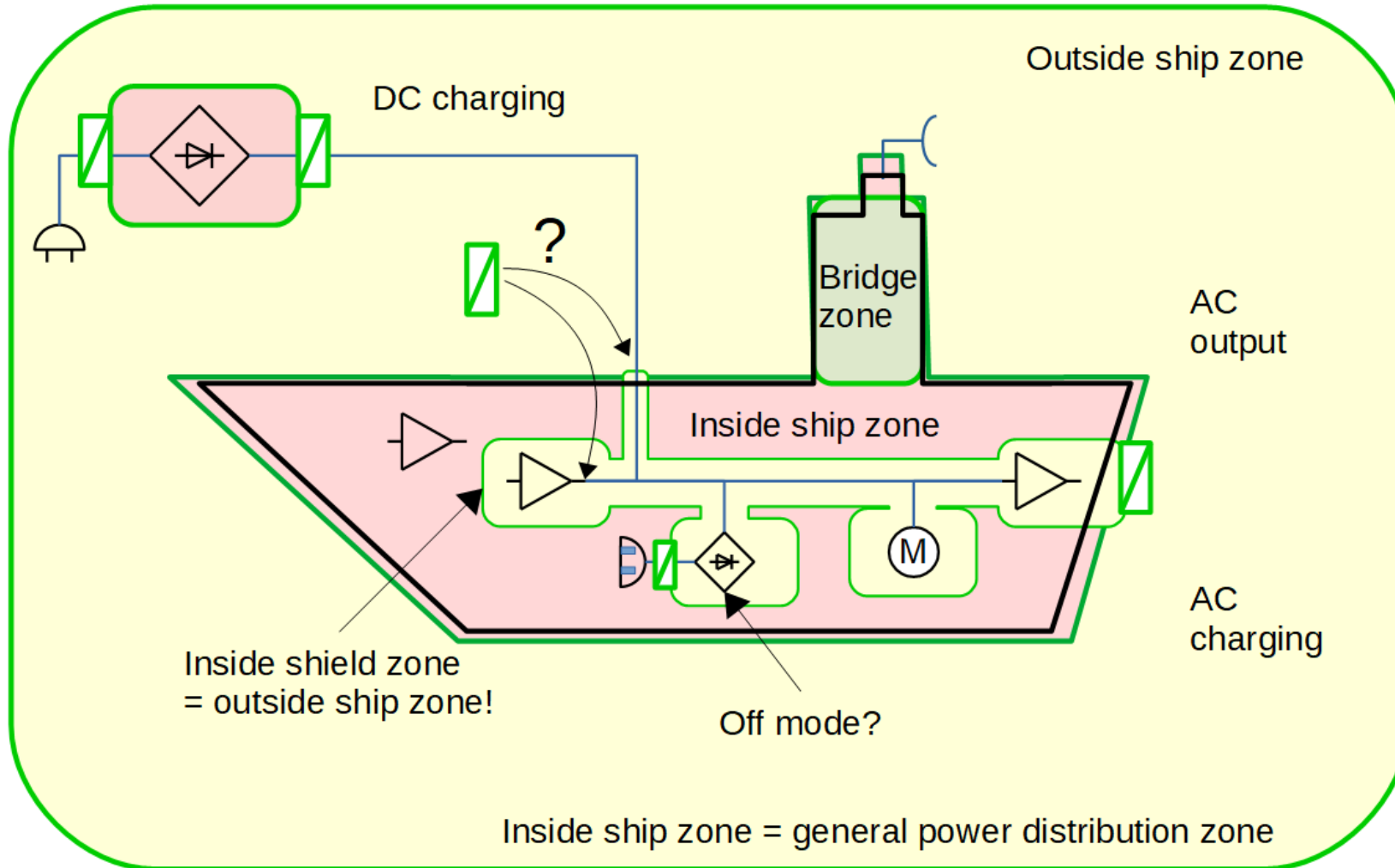
Complete ship – e-mobility basic picture



Complete ship – e-mobility zoning AC charge



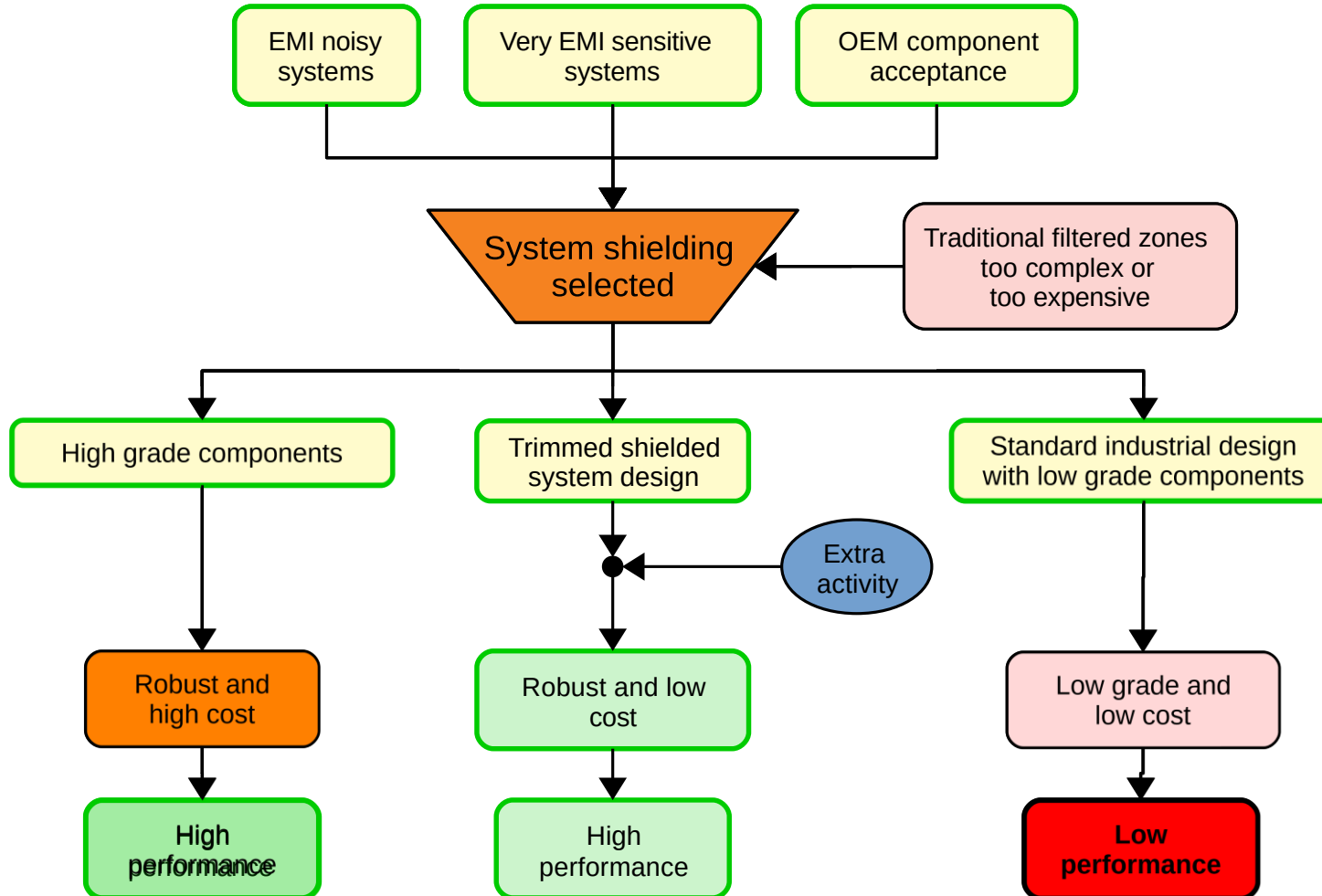
Complete ship – e-mobility zoning DC charge



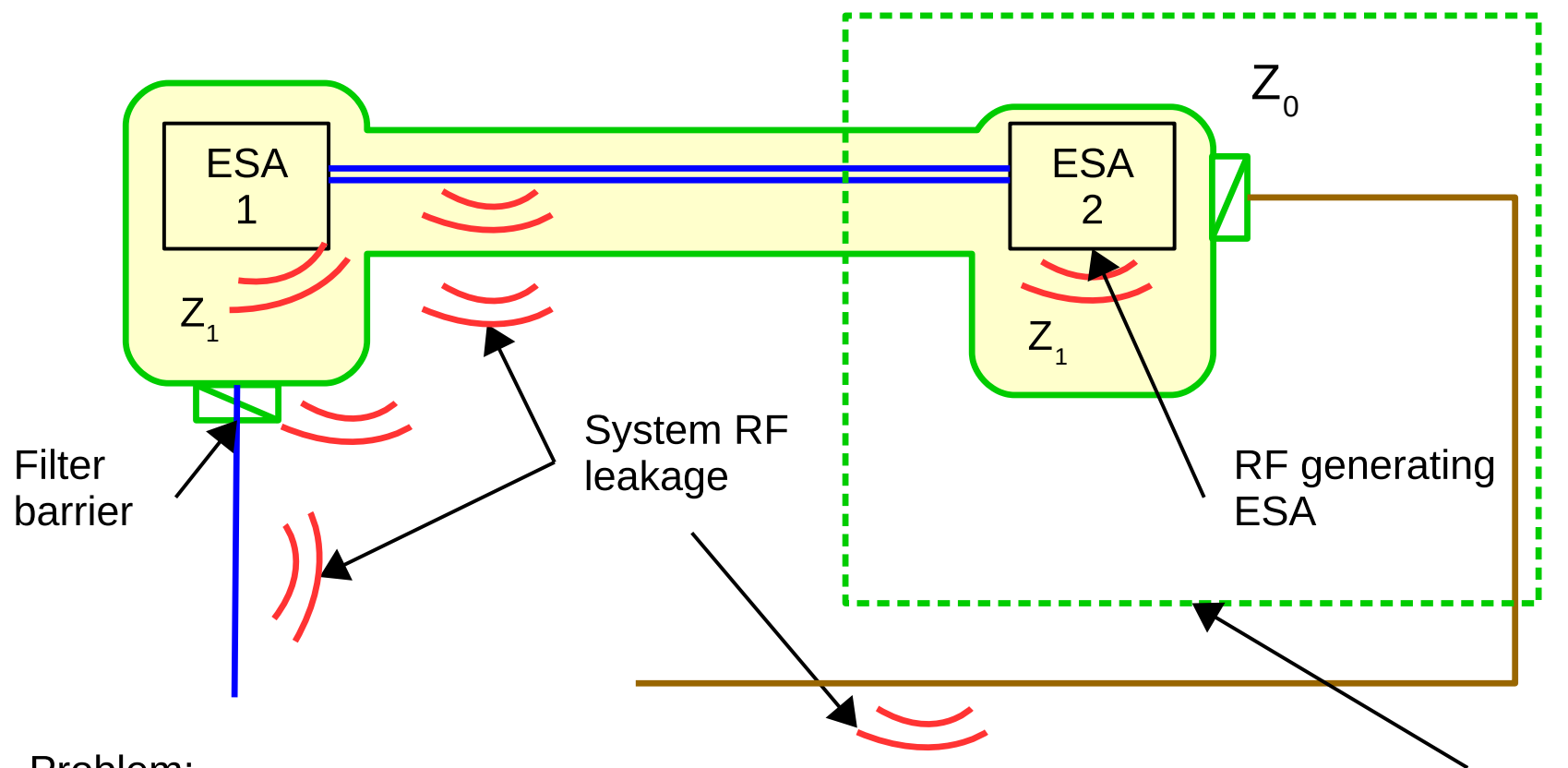
The shielding challenge

Proposals and discussion

3 ways of shielding



Risk: Leaking system including cables

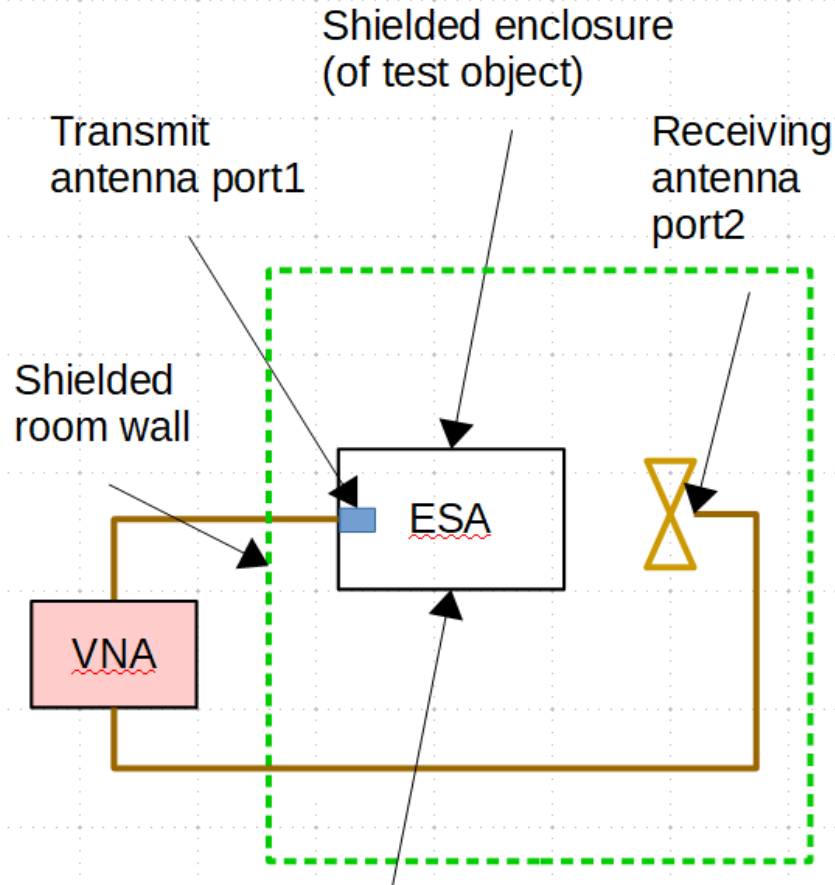


Problem:

- System leakage generated outside ESA1 and ESA2
- How to discover this prior to complete system test?
- How to verify ESA1?
- What requirement?

Test volume for ESA2

Option: SE requirement on ESA + interfaces



No space for antenna in ESA

Approach:

Measure the attenuation through the enclosure

Alternatives:

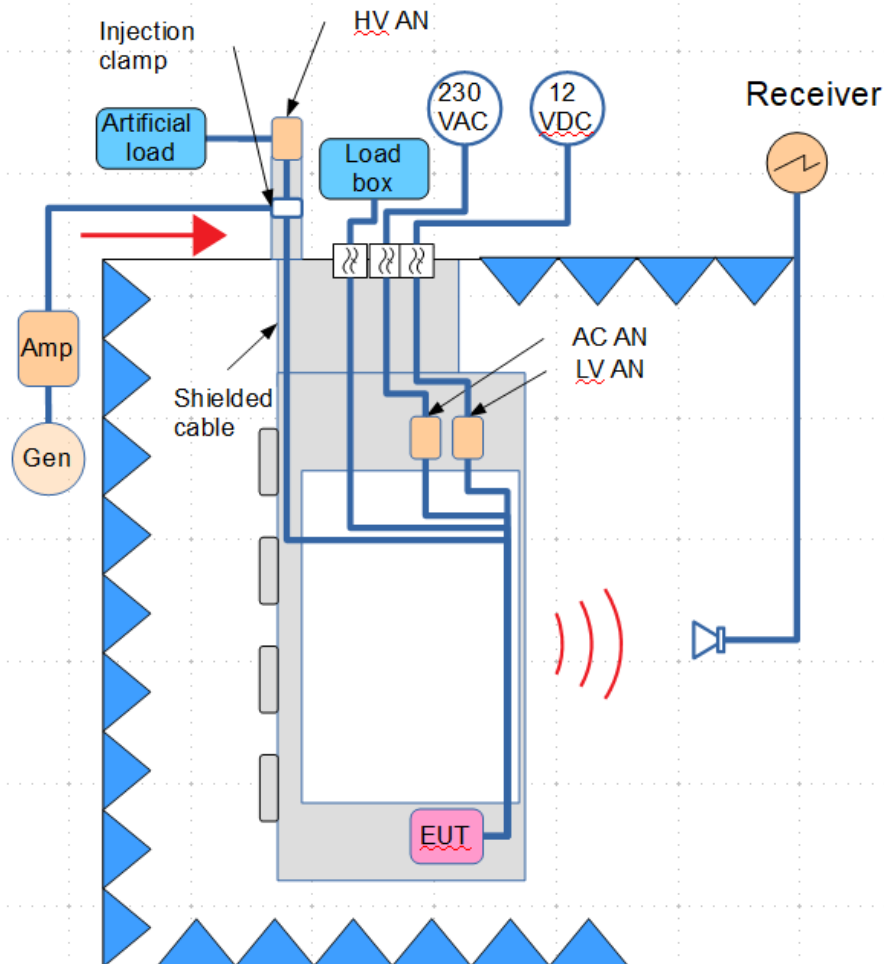
- Figure: Standard IEEE 299 for radiated cabinet measurement
- CISPR25 method for conducted measurements (transfer methods)
- many IEC standards for cables and connectors

Cons for IEEE 299:

- 30-300 MHz not covered for enclosures
- Interfaces of connectors and cables may be missed in IEEE method
- What shielding level shall be specified
- Electronic HW influence may be missed

Methods for cables + connectors OK

Option: Injection on ESA during emission measurement



Approach:

Simulate the actual worst case disturbance generator

- Needs to be tailored for each project

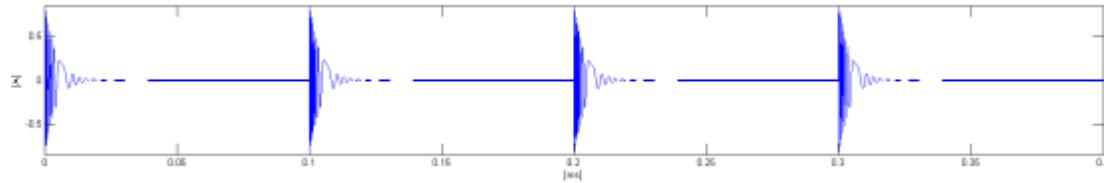
Pros:

- All interfaces, connectors and cables are included – must be specified!
- Test is integrated into regular test setup
- No tailored test items (EUT)
- Active system: Electronic HW influence included

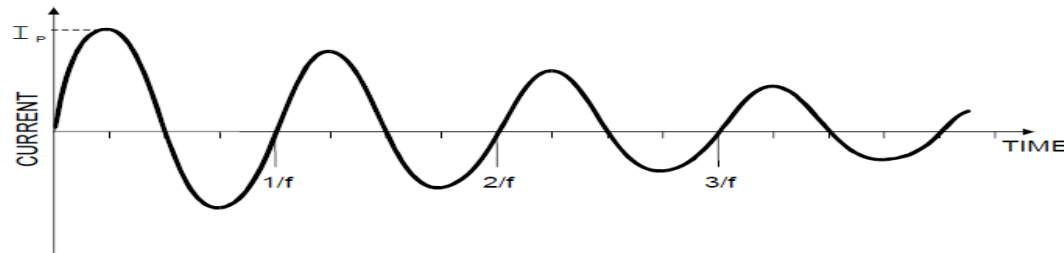
Cons:

- How to specify the injection
- The major source must be known
- **Pulse generator is complicated**
- The laboratory must be prepared!

Component testing, induced pulse frequency pulse shape



Broadband (more advanced)



Damped sinusoidal (MIL-std)

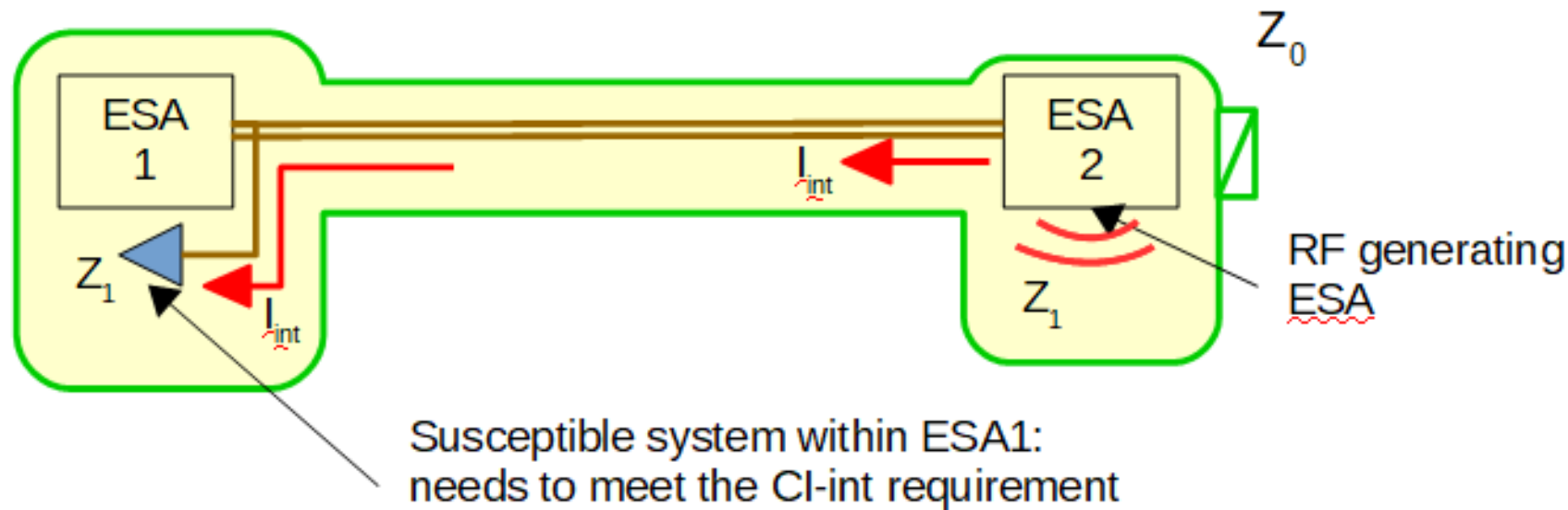
X

Or some other pulse/method?

The challenge inside the shield

Ideas and proposals

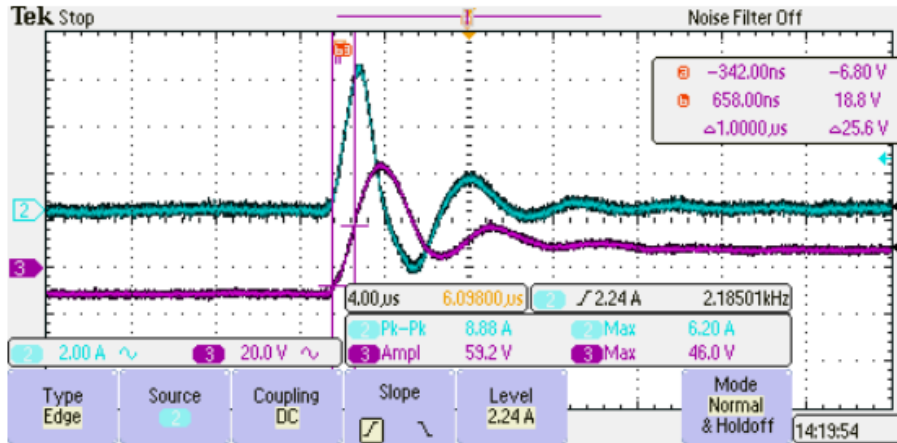
Risk: Internal immunity – and emission



Problem:

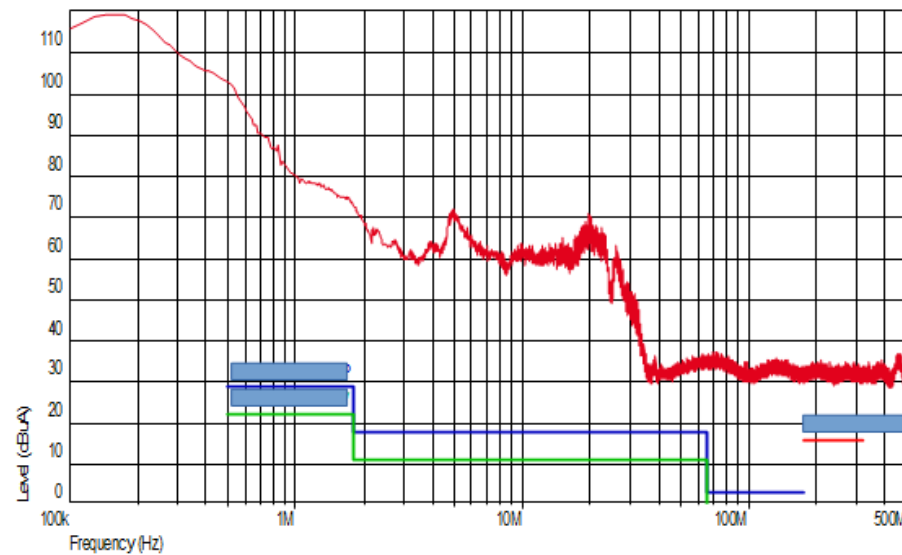
- Noisy internal system creates interference in adjacent internal system
- Tailored specification
 - Matching requirements Conducted Susceptibility vs Emission
 - With margin
- Main coupling path = current path between components
- Requirement related to main RF generator
- Result: *the EM environment within the shielded system is specified and known!*

Measurement example on TVB



I_{CM} internal TVB pos lead

U_{CM} internal TVB pos - GND

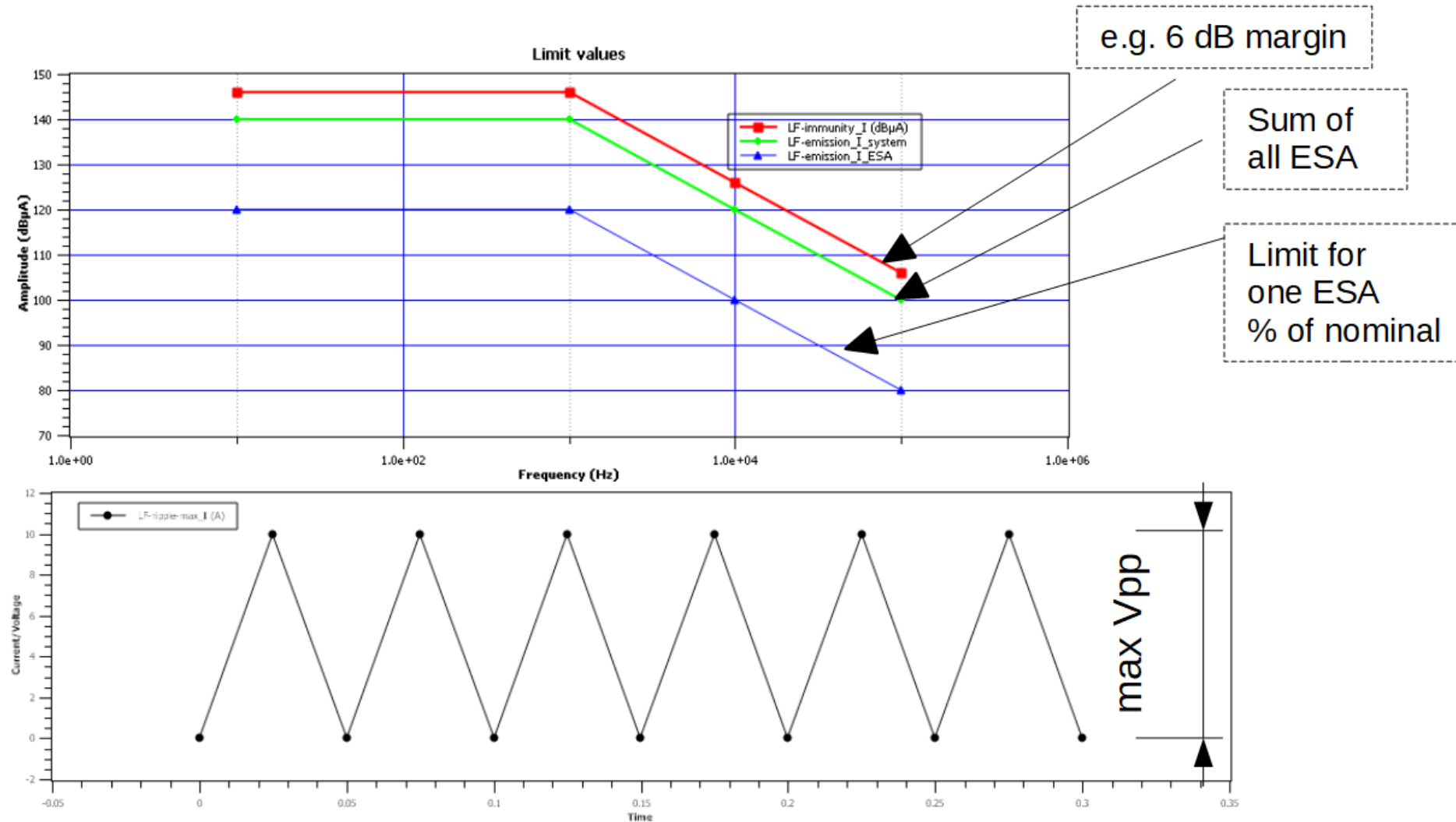


I_{CM} internal TVB pos lead

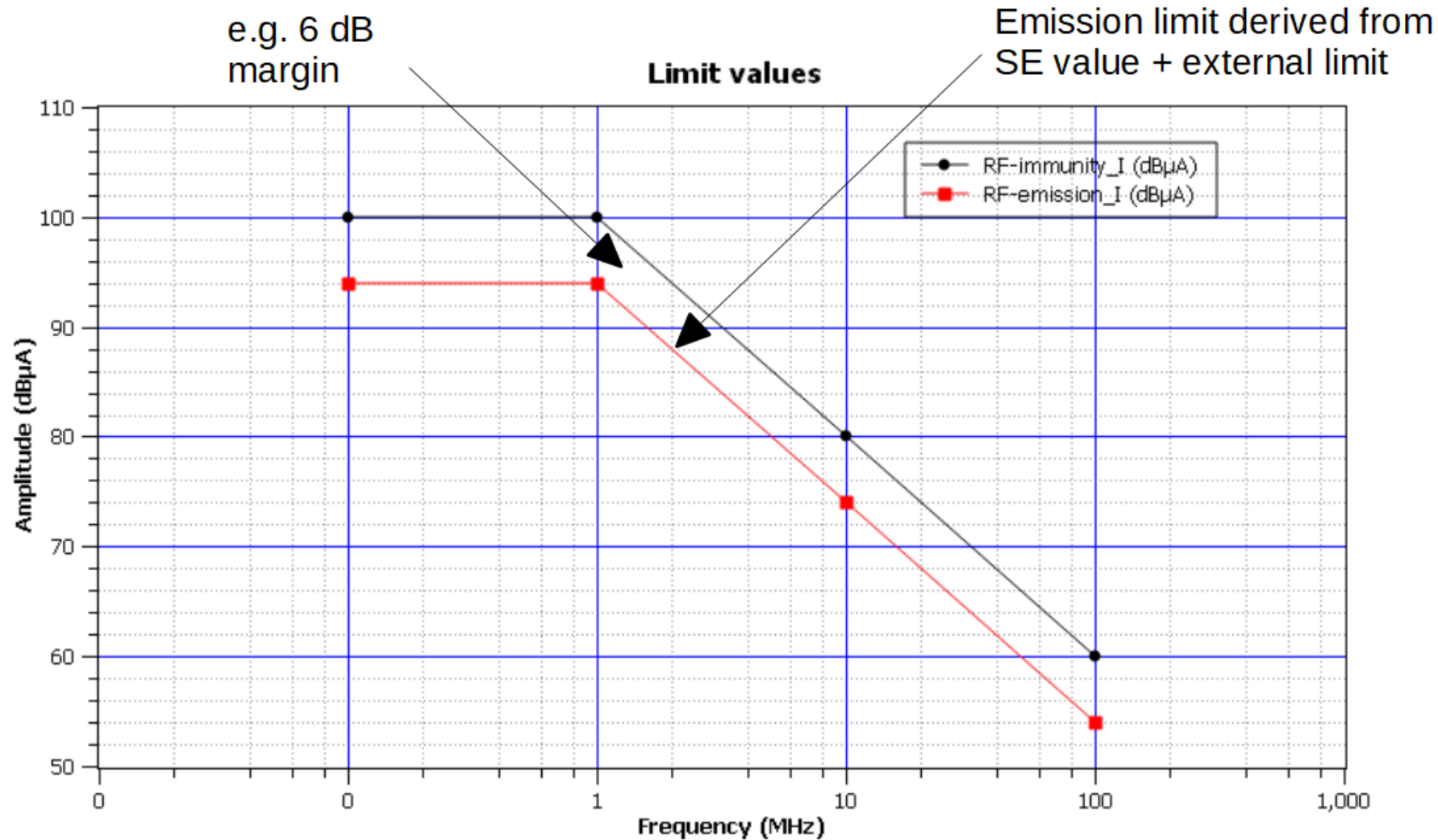
Technical rationale

- The ripple test (emission and immunity) at **low** frequencies is intended to simulate the effect of high ripple current into the test object
 - Overheating
 - Possible interference to sensors
 - Dominant differential mode
- RF emission test aims at limiting the source energy inside the shield
 - Protecting radio communication on the outside
- RF pulse immunity aims at testing electronics inside the shield
 - Dominant common mode

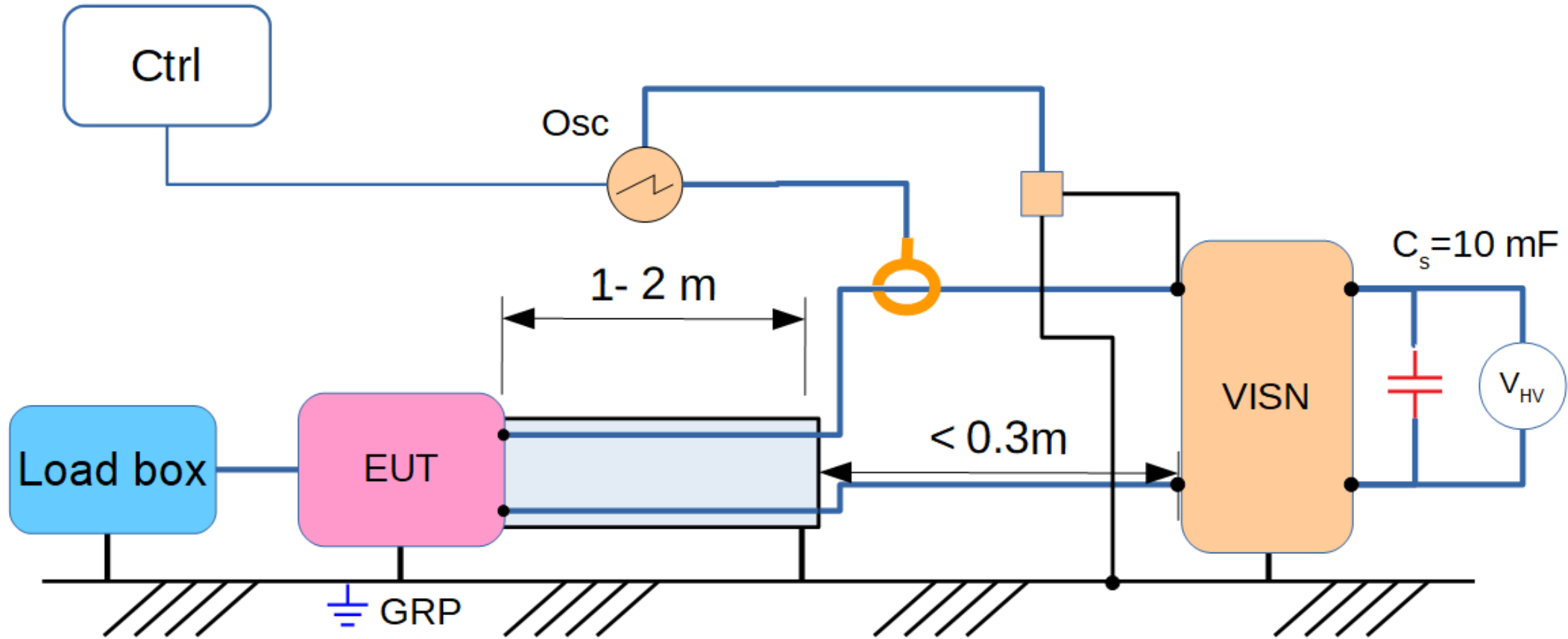
LF ripple limits = ?



RF current emission limits = ?

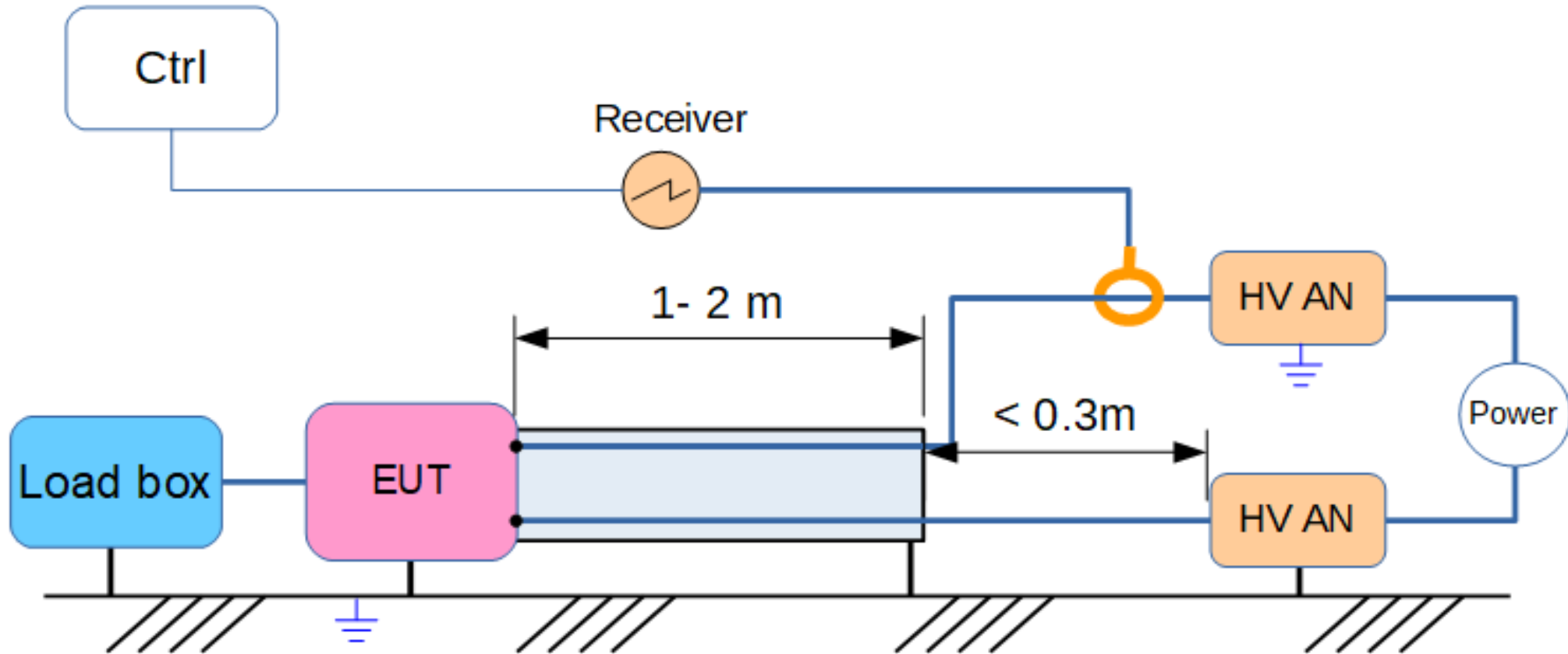


Component testing, LF emission (ripple, $f = 20 \text{ Hz} - 1 \text{ MHz}$) - *Modified ISO 21498*

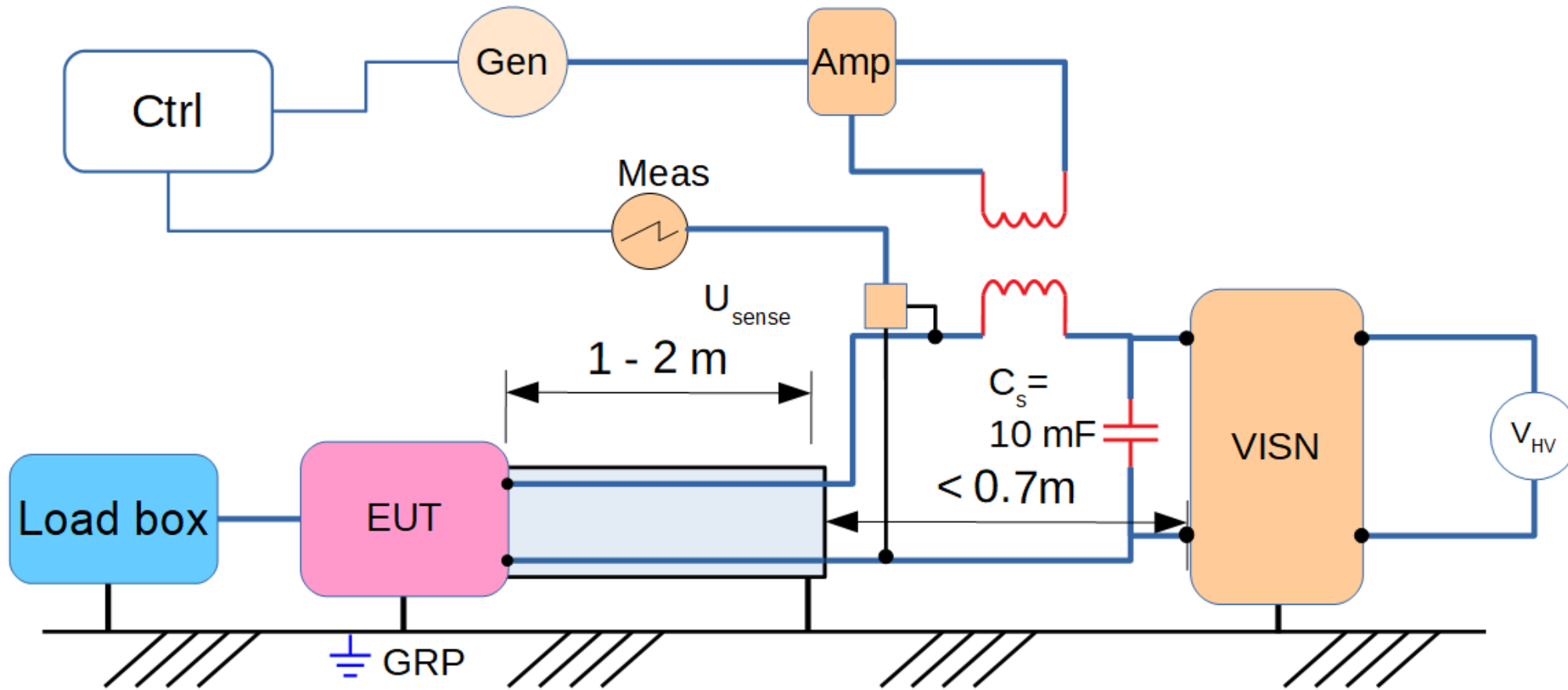


Component testing, conducted RF emission

$f = 100 \text{ kHz} - 250 \text{ MHz}$ - *Modified CISPR25 current method*



Component testing, induced audio frequency (ripple, $f < 100$ kHz) - *Modified ISO 11452-10 (= CS101!)*



RF noise during DC charging

- Solution: turn everything off during charging
 - Including DC/DC converter for 24VDC batteries
 - *EMC Software requirement on system level*
 - Will also handle RF disturbance from external radio transmitters

Summary

Summary

- The risk for system leakage calls for better control
 - E-mobility needs system EMC design
 - Low Cost -> No more cutting the corners
- Component level requirement for shielded system
 - Needs tailoring
- New test methods in development
 - LF internal ripple emission and immunity
 - RF internal emission and immunity
 - RF shielding requirements – including passive components